Features

• 2.7 to 3.6V Supply

Full Read and Write Operation

- Low Power Dissipation
 - 8 mA Active Current

50 μA CMOS Standby Current

- Read Access Time 250 ns
- Byte Write 3 ms
- Direct Microprocessor Control

DATA Polling

READ/BUSY Open Drain Output on TSOP

High Reliability CMOS Technology

Endurance: 100,000 Cycles
Data Retention: 10 Years

- Low Voltage CMOS Compatible Inputs and Outputs
- JEDEC Approved Byte Wide Pinout
- Commercial and Industrial Temperature Ranges

Description

The AT28BV16 is a low-power, high-performance Electrically Erasable and Program-mable Read Only Memory with easy to use features. The AT28BV16 is a 16K memory organized as 2,048 words by 8 bits. The device is manufactured with Atmel's reliable nonvolatile CMOS technology.

The AT28BV16 is accessed like a static RAM for the read or write cycles without the need of external components. During a byte write, the address and data are latched *(continued)*

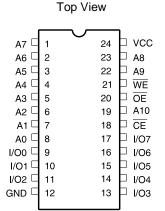
Pin Configurations

| Pin Name | Function |
|-------------|---------------------|
| A0 - A10 | Addresses |
| CE | Chip Enable |
| ŌE | Output Enable |
| WE | Write Enable |
| 1/00 - 1/07 | Data Inputs/Outputs |
| NC | No Connect |
| DC | Don't Connect |

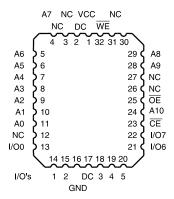
| | | | | TSOP Top View | | | |
|--|-----------------------------------|------------------------------|----|------------------|--|---|---|
| NC A8 WE RDY/BUSY A7 A5 | OE A9 NC VCC NC A6 | 2 4 6 8 10 12 | 11 | | 28 27 26 25 24 23 22 21 20 18 19 18 17 | A10 I/O7 I/O5 I/O3 I/O2 I/O0 | CE I/O6 I/O4 GND I/O1 A0 |
| | A4 | | 13 | | 16 , | Α1 | 4.0 |

PLCC

Top View



PDIP. SOIC



16K (2K x 8)

Battery-Voltage

CMOS

E²PROM

0308A





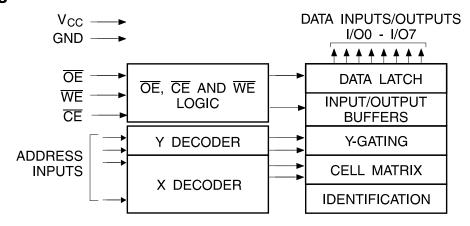
Description (Continued)

internally, freeing the microprocessor address and data bus for other operations. Following the initiation of a write cycle, the device will go to a busy state and automatically clear and write the latched data using an internal control timer. The end of a write cycle can be determined by DATA polling of I/O₇. Once the end of a write cycle has been detected, a new access for a read or a write can begin.

The CMOS technology offers fast access times of 250 ns at low power dissipation. When the chip is deselected the standby current is less than 50 μ A.

Atmel's 28BV16 has additional features to ensure high quality and manufacturability. The device utilizes error correction internally for extended endurance and for improved data retention characteristics. An extra 32-bytes of E²PROM are available for device identification or tracking.

Block Diagram



Absolute Maximum Ratings*

| Temperature Under Bias55°C to +125°C |
|---|
| Storage Temperature65°C to +150°C |
| All Input Voltages (including NC Pins) with Respect to Ground0.6V to +6.25V |
| All Output Voltages with Respect to Ground0.6V to V _{CC} + 0.6V |
| Voltage on \overline{OE} and A9 with Respect to Ground0.6V to +13.5V |

*NOTICE: Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Device Operation

READ: The AT28BV16 is accessed like a Static RAM. When CE and OE are low and WE is high, the data stored at the memory location determined by the address pins is asserted on the outputs. The outputs are put in a high impedance state whenever CE or OE is high. This dual line control gives designers increased flexibility in preventing bus contention.

BYTE WRITE: Writing data into the AT28BV16 is similar to writing into a Static RAM. A low pulse on the WE or CE input with \overline{OE} high and \overline{CE} or \overline{WE} low (respectively) initiates a byte write. The address location is latched on the last falling edge of \overline{WE} (or \overline{CE}); the new data is latched on the first rising edge. Internally, the device performs a self-clear before write. Once a byte write has been started, it will automatically time itself to completion. Once a programming operation has been initiated and for the duration of t_{WC} , a read operation will effectively be a polling operation.

DATA POLLING: The AT28BV16 provides DATA POLLING to signal the completion of a write cycle. During a write cycle, an attempted read of the data being written results in the complement of that data for I/O₇ (the other outputs are indeterminate). When the write cycle is finished, true data appears on all outputs.

READY/BUSY (**TSOP only**): READY/BUSY is an open drain output; it is pulled low during the internal write cycle and released at the completion of the write cycle.

WRITE PROTECTION: Inadvertent writes to the device are protected against in the following ways. (a) Vcc sense— if Vcc is below 2.0V (typical) the write function is inhibited. (b) Vcc power on delay— once Vcc has reached 2.0V the device will automatically time out 5 ms (typical) before <u>allowing a byte write. (c)</u> Write Inhibit— holding any one of \overline{OE} low, \overline{CE} high or \overline{WE} high inhibits byte write cycles.

DEVICE IDENTIFICATION: An extra 32-bytes of E^2PROM memory are available to the user for device identification. By raising A9 to $12\pm0.5V$ and using address locations 7E0H to 7FFH the additional bytes may be written to or read from in the same manner as the regular memory array.





DC and AC Operating Range

| | | AT28BV16-25 | AT28BV16-30 |
|--------------------|------|--------------|--------------|
| Operating | Com. | 0°C - 70°C | 0°C - 70°C |
| Temperature (Case) | Ind. | -40°C - 85°C | -40°C - 85°C |
| Vcc Power Supply | | 2.7V to 3.6V | 2.7V to 3.6V |

Operating Modes

| Mode | CE | ŌĒ | WE | I/O |
|-----------------------|------------------|------------------|----------|-----------------|
| Read | VIL | VIL | VIH | Dout |
| Write (2) | V _I L | VIH | V_{IL} | D _{IN} |
| Standby/Write Inhibit | VIH | X ⁽¹⁾ | X | High Z |
| Write Inhibit | Χ | Χ | VIH | |
| Write Inhibit | X | VIL | Χ | |
| Output Disable | Х | VIH | Х | High Z |

Notes: 1. X can be V_{IL} or V_{IH}.
2. Refer to AC Programming Waveforms.

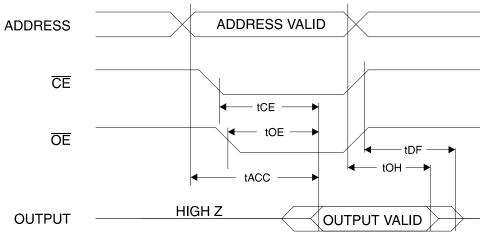
DC Characteristics

| Symbol | Parameter | Condition | Min | Max | Units |
|-----------------|--------------------------------------|---|-----|-----|----------|
| ILI | Input Load Current | $V_{IN} = 0V$ to $V_{CC} + 1.0V$ | | 5 | μΑ |
| ILO | Output Leakage Current | $V_{I/O} = 0V$ to V_{CC} | | 5 | μΑ |
| I _{SB} | V _{CC} Standby Current CMOS | $\overline{\text{CE}}$ = V _{CC} - 0.3V to V _{CC} + 1.0V | | 50 | μΑ |
| Icc | Vcc Active Current AC | $f = 5 \text{ MHz}$; $I_{OUT} = 0 \text{ mA}$; $CE = V_{IL}$ | | 8 | mA |
| VIL | Input Low Voltage | | | 0.6 | V |
| ViH | Input High Voltage | | 2.0 | | V |
| Vol | Output Low Voltage | I _{OL} = 1 mA | | 0.3 | ٧ |
| VOL | Output Low Voltage | $I_{OL} = 2 \text{ mA for RDY/}\overline{BUSY}$ | | 0.3 | V |
| Vон | Output High Voltage | I _{OH} = -100 μA | 2.0 | | V |

AC Read Characteristics

| | | AT28BV16-25 AT28BV16-30 | | BV16-30 | | |
|------------------------|--|-------------------------|-----|---------|-----|-------|
| Symbol | Parameter | Min | Max | Min | Max | Units |
| tACC | Address to Output Delay | | 250 | | 300 | ns |
| tce (1) | CE to Output Delay | | 250 | | 300 | ns |
| toE (2) | OE to Output Delay | | 100 | | 100 | ns |
| t _{DF} (3, 4) | CE or OE High to Output Float | 0 | 55 | 0 | 55 | ns |
| tон | Output Hold from OE, CE or Address, whichever occurred first | 0 | | 0 | | ns |

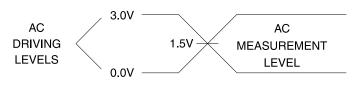
AC Read Waveforms (1, 2, 3, 4)



Notes: 1. $\overline{\text{CE}}$ may be delayed up to t_{ACC} - t_{CE} after the address transition without impact on t_{ACC}.

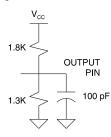
- 2. OE may be delayed up to t_{CE} t_{OE} after the falling edge of CE without impact on t_{CE} or by t_{ACC} t_{OE} after an address change without impact on t_{ACC}.
- 3. t_{DF} is specified from \overline{OE} or \overline{CE} whichever occurs first $(C_L = 5 \text{ pF})$.
- 4. This parameter is characterized and is not 100% tested.

Input Test Waveforms and Measurement Level



 t_R , $t_F < 20 \text{ ns}$

Output Test Load



Pin Capacitance (f = 1 MHz, T = 25°C) (1)

| | Тур | Max | Units | Conditions |
|-----------------|-----|-----|-------|---------------|
| C _{IN} | 4 | 6 | pF | $V_{IN} = 0V$ |
| Соит | 8 | 12 | pF | Vout = 0V |

Note: 1. This parameter is characterized and is not 100% tested.



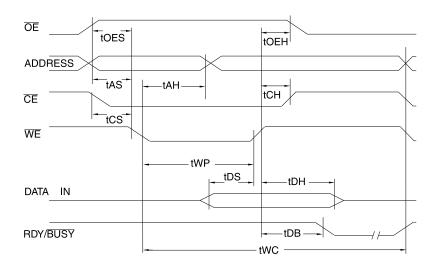


AC Write Characteristics

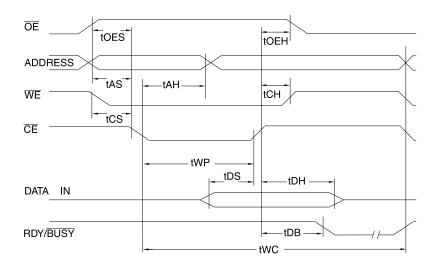
| Symbol | Parameter | Min | Max | Units |
|------------------------------------|--|-----|------|-------|
| tas, toes | Address, OE Set-up Time | 10 | | ns |
| tah | Address Hold Time | 100 | | ns |
| twp | Write Pulse Width (WE or CE) | 150 | 1000 | ns |
| tos | Data Set-up Time | 100 | | ns |
| t _{DH} , t _{OEH} | Data, OE Hold Time | 10 | | ns |
| tcs, tch | CE to WE and WE to CE Set-up and Hold Time | 0 | | ns |
| twc | Write Cycle Time | | 3.0 | ms |
| t _{DB} | Time to Device Busy | | 50 | ns |

AC Write Waveforms

WE Controlled



CE Controlled



AT28BV16

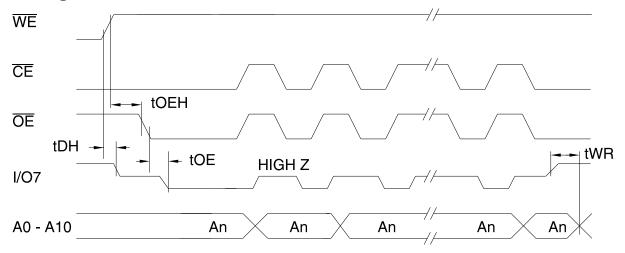
Data Polling Characteristics (1)

| Symbol | Parameter | Min | Тур | Max | Units |
|--------|------------------------|-----|-----|-----|-------|
| tDH | Data Hold Time | 10 | | | ns |
| toeh | OE Hold Time | 10 | | | ns |
| toE | OE to Output Delay (2) | | | | ns |
| twR | Write Recovery Time | 0 | | | ns |

Notes: 1. These parameters are characterized and not 100% tested.

2. See AC Characteristics.

Data Polling Waveforms





Ordering Information (1)

| tACC | Icc | (mA) | Ordering Code | Do al ana | Omenation Berne |
|------|--------|---------|--|---------------------------|-------------------------------|
| (ns) | Active | Standby | Ordering Code | Package | Operation Range |
| 250 | 8 | 0.05 | AT28BV16-25TC AT28BV16-25JC AT28BV16-25PC AT28BV16-25SC | 28T 32J 24P6 24S | Commercial (0°C to 70°C) |
| | 8 | 0.05 | AT28BV16-25TI AT28BV16-25JI AT28BV16-25PI AT28BV16-25SI | 28T 32J 24P6 24S | Industrial (-40°C to 85°C) |
| 300 | 8 | 0.05 | AT28BV16-30TC AT28BV16-30JC AT28BV16-30PC AT28BV16-30SC | 28T 32J 24P6 24S | Commercial (0°C to 70°C) |
| | 8 | 0.05 | AT28BV16-30TI AT28BV16-30JI AT28BV16-30PI AT28BV16-30SI | 28T 32J 24P6 24S | Industrial (-40°C to 85°C) |

Note: 1. See Valid Part Number table below.

Valid Part Numbers

The following table lists standard Atmel products that can be ordered.

| Device Numbers | Speed | Package and Temperature Combinations | |
|----------------|-------|--------------------------------------|--|
| AT28BV16 | 25 | JC, JI, PC, PI, SC, SI, TC, TI | |
| AT28BV16 | 30 | JC, JI, PC, PI, SC, SI, TC, TI | |

| Package Type | |
|--------------|--|
| 28T | 28 Lead, Plastic Thin Small Outline Package (TSOP) |
| 32J | 32 Lead, Plastic J-Leaded Chip Carrier (PLCC) |
| 24P6 | 24 Lead, 0.600" Wide, Plastic Dual Inline Package (PDIP) |
| 24S | 24 Lead, 0.300" Wide, Plastic Gull Wing Small Outline (SOIC) |

AT28BV16 ____